



SPECIFICATION

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SPEC. NO.: PS-50185-XXXXX-XXX

REVISION: E

PRODUCT NAME: 0.4 mm BTB D/R CONN SMT S/T TYPE

PRODUCT NO: 50185 SERIES ,51165 SERIES

APPROVED: ZHUWEI DATE: 2020/04/28	CHECKED: BRAVE DATE: 2020/04/28	PREPARED: BRAVE DATE: 2020/04/28
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TITLE: 0.4 MM BTB D/R CONN SMT S/T TYPE

RELEASE DATE: 2020/04/28

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ECN No: ECN-200437

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Aces P/N: **50185 series 51165 series**

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1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
1	0911187	FOR PDR APD980463 NEW REV	ALEX	09/12/03
O	1003011	RELEASE	ALEX	10/03/04
A	1106185	ADD CONNECTOR USAGE	ALEX	11/06/14
B	ECN-1401262	UPDATE WORKING VOLTAGE	FENGXIAO	2014/01/18
C	ECN-1604256	modify Salt Spray Standard	CHENYA	2016.02.23
D	ECN-1710330	ADD 51165 series	ZHUWEI	2017.10.23
E	ECN-2004437	Amend Operating Temperature	ZHUWEI	2020.04.28

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2 SCOPE

This specification covers performance, tests and quality requirements for **0.4 mm BTB D/R CONN SMT S/T TYPE**, 50185 series.

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

4.1 Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable product drawing.

4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy (**Phosphor Bronze**)
Finish: (a) Contact Area: **Gold plated based on order information**
(b) Under plate: **Nickel-plated all over**
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Nut or Ear: **Copper Alloy, Tin-Lead plated.**

4.3 Ratings

- 4.3.1 Working Voltage Less than **36 Volts AC (per pin)**
- 4.3.2 Voltage: **50 Volts AC (per pin)**
- 4.3.3 Current: **0.5 Amperes (per pin)**
- 4.3.4 Operating Temperature : **-40°C to +85°C**

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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
ELECTRICAL		
Item	Requirement	Standard
Low Level Contact Resistance	70 m Ω Max.(initial)per contact 20 m Ω Max. Change allowed	Mate connectors, measure by dry circuit, 20mV Max., 10mA Max. (EIA-364-23)
Insulation Resistance	1000 M Ω Min.	Unmated connectors, apply 250 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	250 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)
MECHANICAL		
Item	Requirement	Standard
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 \pm 3mm/min. (EIA-364-09)
Mating / Unmating Forces	See figure 1.	Operation Speed : 25.4 \pm 3 mm/minute.. Measure the force required to mate/Unmate connector. (EIA-364-13)
Terminal / Housing Retention Force	0.15kgf MIN.	Apply axial pull out force at the speed rate of 25.4 \pm 3 mm/minute. On the terminal assembled in the housing.

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MECHANICAL

Item	Requirement	Standard
Fitting Nail /Housing Retention Force	0.15kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the fitting nail assembled in the housing.
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz . The entire frequency range, from 10 to 55 Hz and return to 10 Hz , shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

ENVIRONMENTAL

Item	Requirement	Standard
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 4 (Lead Free)	Pre Heat : 150°C~180°C, 60~120sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max.
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31, Condition A, Method II)

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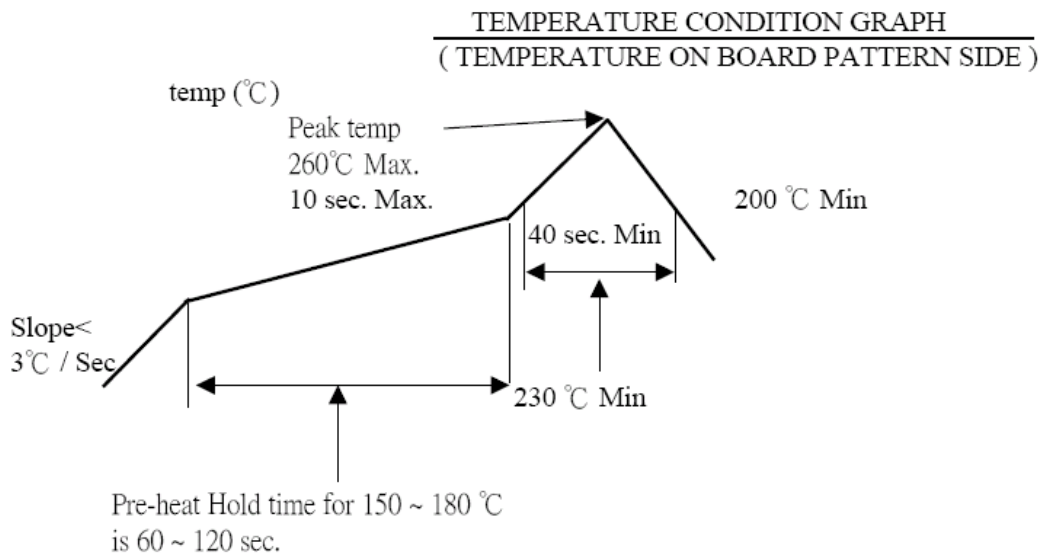
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Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 85°C for 96 hours. (EIA-364-17, Test condition A)
Salt Spray	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating $\geq 5 \mu$ for 96 hours.. (EIA-364-26, Test condition B)
Solder ability	Solder able area shall have minimum of 95% solder coverage.	Subject the test area of contacts into the flux for 5-10 sec. And then into solder bath, Temperature at 245 ± 5 °C , for 4-5 sec. (EIA-364-52)

Note. Flowing Mixed Gas shall be conducted by customer request.

6 INFRARED REFLOW CONDITION

6.1. Lead-free Process



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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination	Test Group									
	1	2	3	4	5	6	7	8		
	Test Sequence									
Examination of Product				1、7	1、6	1、4				
Low Level Contact Resistance		1、5	1、4	2、8	2、9	2、5				
Insulation Resistance				3、9	3、8					
Dielectric Withstanding Voltage				4、10	4、7					
Temperature rise	1									
Mating / Unmating Forces		2、4								
Durability		3								
Vibration			2							
Shock (Mechanical)			3							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray						3				
Solder ability							1			
Terminal / Housing Retention Force								1		
Fitting Nail /Housing Retention Force								2		
Sample Size	2	4	4	4	4	4	2	4		

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8 MATING/UNMATING FORCE

Unit : N / kg

Number of circuits	Mating force N / kg MAX.				Unmating force N / kg MIN.			
	initial		30 th		initial		30 th	
	N	Kg	N	Kg	N	Kg	N	Kg
10	5.88	0.60	4.90	0.50	0.29	0.03	0.19	0.02
14	9.80	1.00	7.84	0.80	0.68	0.07	0.49	0.05
20	13.72	1.40	10.78	1.10	0.98	0.10	0.78	0.08
26	17.84	1.82	14.01	1.43	1.27	0.13	0.98	0.10
30	20.58	2.10	16.17	1.65	1.47	0.15	1.18	0.12
34	24.00	2.50	18.80	1.92	1.70	0.17	1.30	0.14
40	27.44	2.80	21.56	2.20	1.96	0.20	1.57	0.16
50	34.30	3.50	26.95	2.75	2.45	0.25	1.96	0.20
60	41.16	4.20	32.34	3.30	2.94	0.30	2.35	0.24
70	48.02	4.90	37.73	3.85	3.43	0.35	2.74	0.28
80	54.88	5.60	43.12	4.40	3.92	0.40	3.14	0.32
90	61.74	6.30	48.51	4.95	4.41	0.45	3.53	0.36
100	68.60	7.00	53.90	5.50	4.90	0.50	3.92	0.40
110	75.46	7.70	59.29	6.05	5.39	0.55	4.31	0.44
120	82.32	8.40	64.68	6.60	5.88	0.60	4.70	0.48

9 CONNECTOR USAGE

